SOOS020 D3262, JUNE 1989

- Dual-Channel Optocouplers
- High Current Transfer Ratio . . . 1800% Typ at Ip = 0.5 mA
- Low Input Current Requirement . . . 0.5 mA
- High-Speed Switching . . . 100 kbit/s Typ
- High Common-Mode Transient Immunity . . . 500 V/μs Typ
- High-Voltage Electrical Insulation . . . 3000 V DC Min
- High Output Current Rating of 60 mA
- UL Recognized . . . File Number 65085

description

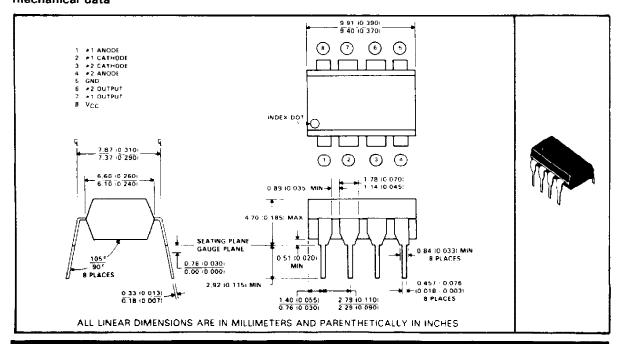
These devices are useful where large common-mode input signals exist, and in applications that require high-voltage isolation between circuits. Applications include line receivers, telephone ring detectors, power line monitors, high-voltage status indicators, and circuits that require isolation between input and output.

The HCPL2730 and HCPL2731 dual-channel high-gain optocouplers each consists of a pair of light-emitting diodes and integrated high-gain photon detectors. The VCC and output terminals may be tied together to achieve conventional photodarlington operation. An integrated emitter-base bypass resistor is provided for low leakage.

The HCPL2730 is designed for use primarily in TTL applications. An LED input current of 1.6 mA and a minimum current-transfer ratio of 300% from 0°C to 70°C allow operation with one TTL-load input and one TTL-load output utilizing a 2.2-k Ω pullup resistor.

The HCPL2731 is designed for use in CMOS, LSTTL, or other low-power applications. This device has a minimum current-transfer ratio of 400% for only 0.5-mA input current over an operating temperature range of 0°C to 70°C.

mechanical data

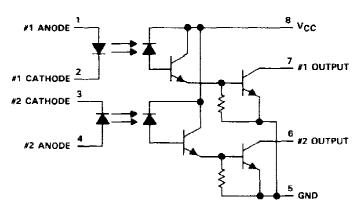


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schematic



absolute maximum ratings at 25 °C free-air temperature range (unless otherwise noted)

Supply and output voltage range, VCC and VO: HCPL27300.5 V to 7 V
HCPL2731 0.5 to 18 V
Reverse input voltage
Peak input forward current per channel (pulse duration = 1 ms, 50% duty cycle) 40 mA
Average forward input current per channel at (or below) 50°C free-air
temperature (see Note 1)
Output current per channel at (or below) 35 °C free-air temperature (see Note 2) 60 mA
Input power dissipation per channel at (or below) 50 °C free-air temperature (see Note 3) 35 mW
Output power dissipation per channel at (or below) 35°C free-air
temperature (see Note 4)
Operating temperature range40°C to 85°C
Storage temperature range55°C to 125°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds

- NOTES: 1. Derate linearly above 50°C free-air temperature at a rate of 0.57 mA/°C.
 - 2. Denate linearly above 35 °C free-air temperature at a rate of 1.2 mA/°C.
 - 3. Denate linearly above 50 °C free-air temperature at a rate of 1.0 mW/°C.
 4. Denate linearly above 35 °C free-air temperature at a rate of 2.0 mW/°C.

electrical characteristics over operating free-air temperature range of 0 °C to 70 °C (unless otherwise noted)

PARAMETER		TEST CONDITIONS		HCPL2730			HCPL2731			UNIT
		TEST CO	MULLIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNII
٧ _F	Input forward voltage	l _F = 1.6 mA,	T _A = 25°C	I	1.5	1.7		1.5	1.7	V
αVF	Temperature coefficient of forward voltage	IF = 1.6 mA			-1.8			- 1.8		mV/°C
VBR	input breakdown voltage	اAپ 10 R = 10	TA = 25°C	5			5			V
_ 	Low-level output voltage	VCC = 4.5 V.	$l_F = 1.6 \text{ mA},$		0.1	0.4				v
		$I_{OL} = 4.8 \text{ mA},$ $V_{CC} = 4.5 \text{ V},$	IF = 1.6 mA,	 				0.1	0.4	
Vol		I _{OL} = 8 mA,	1 _B = 0	ļ						
VOL		V _{CC} = 4.5 V,	$l_F = 5 \text{ mA},$					0.1	0.4	
		IOL = 15 mA,						<u> </u>		
		$V_{CC} = 4.5 V_{i}$	$l_F = 12 \text{ mA},$					0.2	0.4	
		IOL = 24 mA,	$I_B = 0$					0.2	0.4	
		I _{OL} = 24 mA, V _{CC} = 7 V.	Vo = 7 V.		0.1	250				μΑ
				1	U. I	250	ļ			
IOH	High-level output current	V _{CC} = 18 V,	VO = 18 V,					0.05	100	
							ł	0.05	100	
		I _F = 0, V _{CC} = 7 V,	I _O = 0,			_	Ĭ			
	Supply current,			1	4					
ICCH	high-level output	$I_F = 0,$ $V_{CC} = 18 V,$	I∩ = 0,			•				nA
							}	5		
	Supply current, low-level output	IF = 0. V _{CC} = 7 V,	In = 0,				1		_	
		IF1 - 1.6 mA,			0.4		1			
		IB = 0					İ			
CCL		V _{CC} = 18 V,	In = 0,	1					* ***	mA
		""	lp2 = 1.6 mA	1			1	0.6		1
		1 _B = 0		1			ļ			
	Current transfer ratio	V _{CC} = 4.5 V.	$V_{O} = 0.4 V_{c}$	1			!			
		I _F = 0.5 mA,		Ì			400%	1800%		
		See Note 5								
CTR		V _{CC} = 4.5V,	Vn = 0.4 V.							1
		I _F = 1.6 mA,		300%	1000%		500%	1600%		
		See Note 5	ъ							
rii	Input-input resistance	V _{ii} = 500 V	*	1	1011		†	1011		Ω
r _{io}	Input-output resistance	V _{io} = 500 V,	See Note 6	 	1012		 	1012	_	Ω
10	Input-input insulation	V _{ii} = 500 V,		1			1			†
łį;	leakage current	RH = 45%		-	0.005			0.005		μΑ
	Input-output insulation leakage current	V _{io} = 3000 V,	t = 5 s.	1			1			1
lio		1 '-	RH = 45%			1	1		1	μА
סוי		See Note 6		Ì			Ī			
Č.	Input capacitance	Vr = 0.	f = 1 MHz	+	60		 	60		ρF
C _{ii}	Input-input capacitance	f = 1 MHz			0.25		\vdash	0.25		oF.
CIO	Input-output capacitance	f = 1 MHz	See Note 6	+	0.6		†	0.6		pF

 $^{^{\}dagger}$ All typical values are at $V_{CC} = 5$ V, $T_{A} = 25$ °C, unless otherwise noted.

NOTES: 5. Current transfer ratio is defined as the ratio of output collector current I_Q to the forward LED input current I_F times 100%.
6. These parameters are measured between pins 2 and 3 shorted together and pins 5, 6, 7 and 8 shorted together.

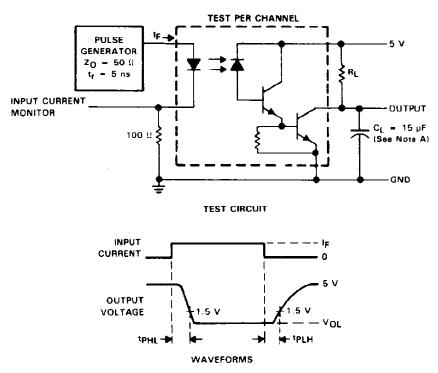
switching characteristics at VCC = 5 V, TA = 25 °C

		TEST CONDITIONS		HCPL2730			HCPL2731			
	PARAMETER			MIN	AIN TYP MAX	MIN	TYP	MAX	UNIT	
	Propagation delay time, high-to-low level output	I _F = 1.6 mA, See Figure 1	$R_L = 2.2 k\Omega$,		2	20		2	20	
^t PHL		l ⁻	R _L = 4.7 kΩ			·		7	100	μS
		I _F = 12 mA. See Figure 1	$R_L = 270 \Omega$		0.4	2		0.4	2	
	Propagation delay time, low-to-high-level output	I _F = 1.6 mA. See Figure 1	$R_L = 2.2 \text{ k}\Omega$		4	35		5	35	
^t PLH		l '	$R_L = 4.7 \text{ k}\Omega$					6	60	μS
		I _F = 12 mA. See Figure 1	$R_L = 270 \Omega$		3	10	•	2	10	
dV _{CM} (H)	Common-mode input transient immunity, high-level output	V _{CM} = 10 Vp-p, R _L = 2.2 kΩ, See Figure 2	I _F = 0, See Notes 7 and 8,		500			500		V/μs
dVCM (L)	Common-mode input transient immunity, low-level output	$V_{CM} = 10 \text{ Vp-p},$ $R_L = 2.2 \text{ k}\Omega,$ See Notes 7 and 8	See Figure 2		- 500			- 500		V/μs

- NOTES: 7. Common-mode transient immunity, high-level output, is the maximum rate of rise of the common-mode input voltage that does not cause the output voltage to drop below 2 V. Common-mode input transient immunity, low-level output, is the maximum rate of fall of the common-mode input voltage that does not cause the output voltage to rise above 0.8 V.
 - In applications where dV/dt may exceed 50,000 V/μs (such as static discharge) a series resistor, R_{CC}, should be included to protect the detector IC from destructively high surge currents. The recommended value is:

$$R_{CC} \approx \frac{1}{0.15 \; l_F \; lmA)} \; k\Omega$$

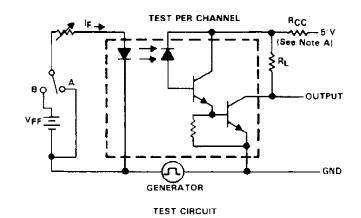
PARAMETER MEASUREMENT INFORMATION

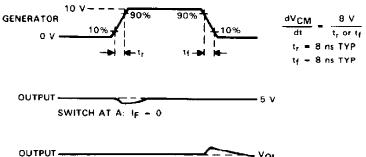


NOTE A: CL includes probe and stray capacitances.

FIGURE 1. SWITCHING TEST CIRCUIT AND WAVEFORMS

PARAMETER MEASUREMENT INFORMATION





SWITCH AT B: IF = 1.6 mA

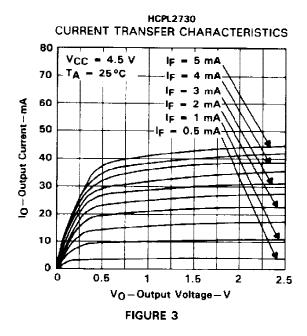
WAVEFORMS

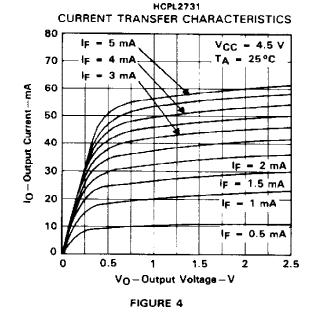
NOTE A: In applications where dV/dt may exceed 50,000 V/µs (such as static discharge) a series resistor, R_{CC}, should be included to protect the detector IC from destructively high surge currents. The recommended value is:

$$R_{CC} \, \cong \, \frac{1}{0.15 \, I_F \, (mA)} \, k \Omega$$

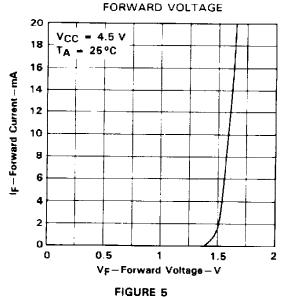
FIGURE 2. TRANSIENT IMMUNITY TEST CIRCUIT AND WAVEFORMS

TYPICAL CHARACTERISTICS





INPUT DIODE FORWARD CURRENT vs





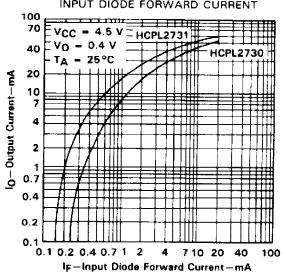
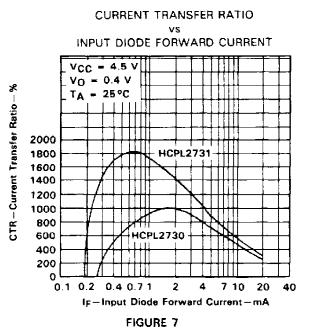
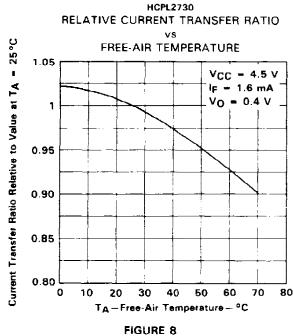
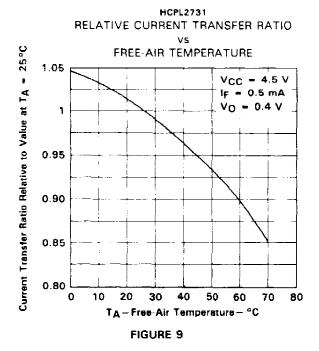


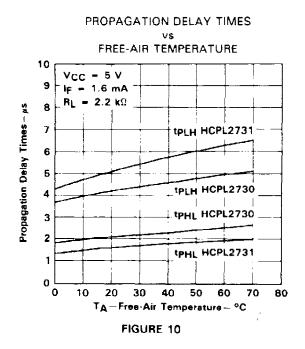
FIGURE 6

TYPICAL CHARACTERISTICS



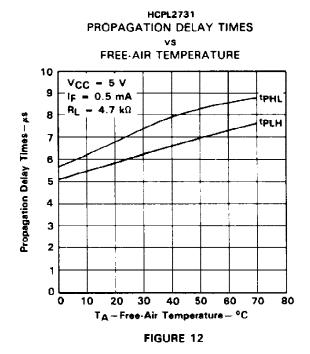






TYPICAL CHARACTERISTICS

PROPAGATION DELAY TIMES FREE-AIR TEMPERATURE 5 VCC - 5 V IF = 12 mA _R_L = 270 Ω Propagation Delay Times - µs tPLH-HCPL2730 3 tPLH-HCPL2731 2 1 tPHL-HCPL2730 tPHL-HCPL2731 0 0 10 40 50 60 70 TA-Free-Air Temperature - °C FIGURE 11



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